

CEI AER8121

UV WAFER ERASER

APPLICATIONS:

- ➔ *Complete erasing of charges of EPROM & Flash memory.*
- ➔ *UV curing and hardening.*
- ➔ *Removal of stress induce due to manufacturing processes.*

FEATURES:

- *300mm ready*
- *Class 10 cleanliness*
- *Modular design for future expansion*
- *Capable of handling thin wafer*
- *GEM full compliance*
- *Wafer sort - FOUP to FOUP or FOUP to FOSB*

